

# 74AHC1G4214

## 14-stage divider and oscillator

Rev. 3 — 26 April 2018

Product data sheet

## 1 General description

74AHC1G4214 is a 14-stage divider and oscillator. It consists of a chain of 14 flip-flops. Each flip-flop divides the frequency of the previous flip-flop by two, consequently the 74AHC1G4214 counts up to  $2^{14} = 16384$ . The single inverting stage (X1 to X2) functions as a crystal oscillator or an input buffer for an external oscillator. When used as a buffer the output X2 should be left floating. The frequency of the output (Q) is the frequency applied to X1 divided by 16384. The divider advances on the negative-going transition of X1.

The X1 input is overvoltage tolerant. This feature allows the use of this device as a voltage level translator in mixed voltage environments.

## 2 Features and benefits

- Wide supply voltage range from 2.0 V to 5.5 V
- Overvoltage tolerant inputs to 5.5 V
- High noise immunity
- CMOS low power dissipation
- ESD protection:
  - HBM JESD22-A114F: exceeds 2000 V
  - CDM JESD22-C101E: exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

## 3 Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AHC1G4214GW	-40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1

## 4 Marking

Table 2. Marking codes

Type number	Marking <sup>[1]</sup>
74AHC1G4214GW	C4

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

## 5 Functional diagram

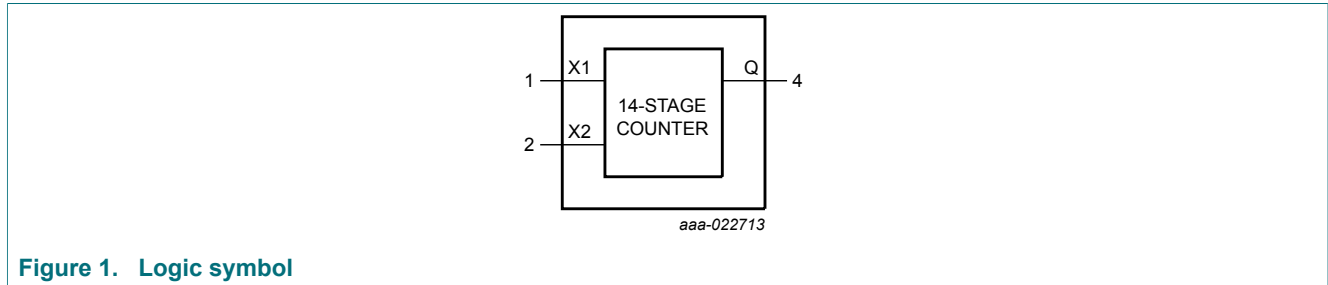


Figure 1. Logic symbol

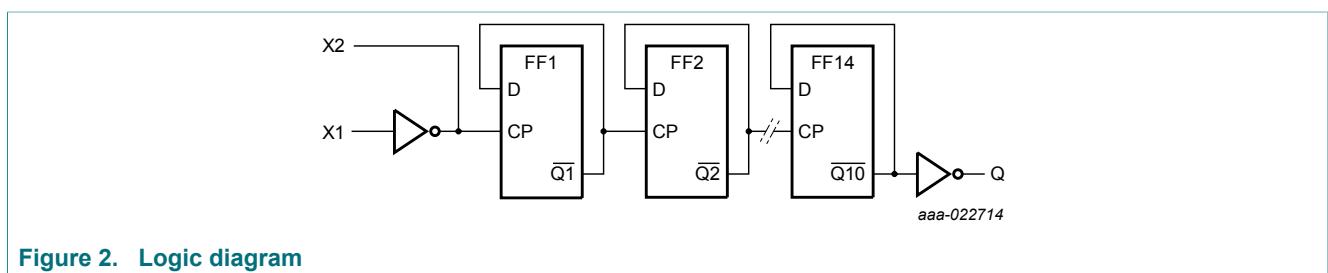


Figure 2. Logic diagram

## 6 Pinning information

### 6.1 Pinning

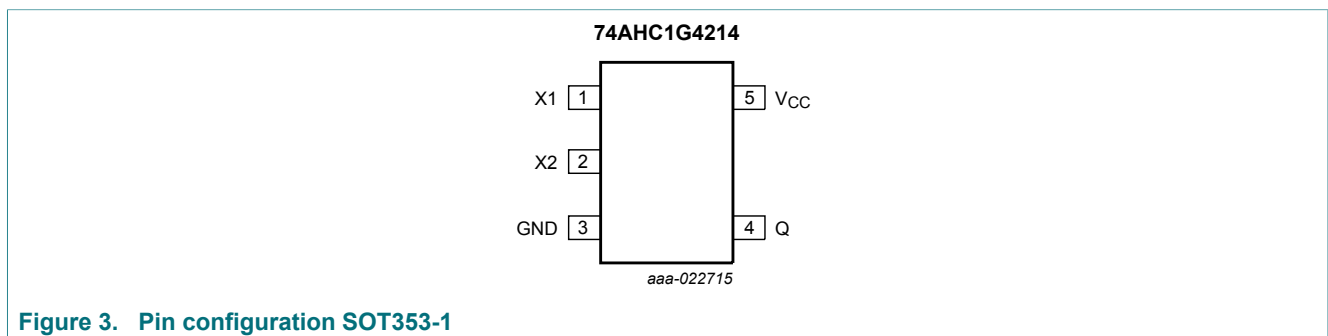


Figure 3. Pin configuration SOT353-1

### 6.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
X1	1	clock input/oscillator pin
X2	2	oscillator pin
GND	3	ground (0 V)
Q	4	divider output
V <sub>CC</sub>	5	supply voltage

## 7 Functional description

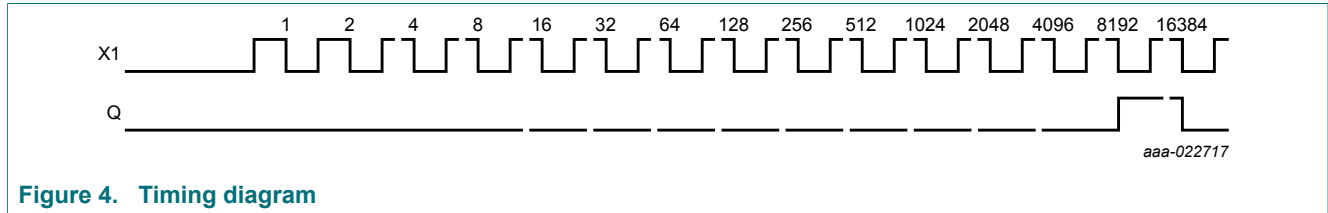


Figure 4. Timing diagram

## 8 Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7.0	V
$V_I$	input voltage		-0.5	+7.0	V
$I_{IK}$	input clamping current	$V_I < -0.5$ V	-20	-	mA
$I_{OK}$	output clamping current	$V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V <sup>[1]</sup>	-	±20	mA
$I_O$	output current	$-0.5$ V < $V_O$ < $V_{CC} + 0.5$ V	-	±25	mA
$I_{CC}$	supply current		-	75	mA
$I_{GND}$	ground current		-75	-	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation	$T_{amb} = -40$ °C to +125 °C <sup>[2]</sup>	-	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP5 package: above 87.5 °C the value of  $P_{tot}$  derates linearly with 4.0 mW/K.

## 9 Recommended operating conditions

**Table 5. Recommended operating conditions**

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{CC}$	supply voltage		2.0	5.0	5.5	V
$V_I$	input voltage		0	-	5.5	V
$V_O$	output voltage		0	-	$V_{CC}$	V
$T_{amb}$	ambient temperature		-40	+25	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	-	-	100	ns/V
		$V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	-	-	20	ns/V

## 10 Static characteristics

**Table 6. Static characteristics**

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
$V_{IH}$	HIGH-level input voltage	X1								
		$V_{CC} = 2.0 \text{ V}$	1.7	-	-	1.7	-	1.7	-	V
		$V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.4	-	2.4	-	V
		$V_{CC} = 5.5 \text{ V}$	4.4	-	-	4.4	-	4.4	-	V
$V_{IL}$	LOW-level input voltage	X1								
		$V_{CC} = 2.0 \text{ V}$	-	-	0.3	-	0.3	-	0.3	V
		$V_{CC} = 3.0 \text{ V}$	-	-	0.6	-	0.6	-	0.6	V
		$V_{CC} = 5.5 \text{ V}$	-	-	1.1	-	1.1	-	1.1	V
$V_{OH}$	HIGH-level output voltage	Q; $V_I = V_{IH}$ or $V_{IL}$								
		$I_O = -50 \mu\text{A}; V_{CC} = 2.0 \text{ V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -50 \mu\text{A}; V_{CC} = 3.0 \text{ V}$	2.9	3.0	-	2.9	-	2.9	-	V
		$I_O = -50 \mu\text{A}; V_{CC} = 4.5 \text{ V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_O = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.8	-	3.70	-	V
		X2; $V_I = V_{IH}$ or $V_{IL}$								
		$I_O = -50 \mu\text{A}; V_{CC} = 2.0 \text{ V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -50 \mu\text{A}; V_{CC} = 3.0 \text{ V}$	2.9	3.0	-	2.9	-	2.9	-	V
		$I_O = -50 \mu\text{A}; V_{CC} = 4.5 \text{ V}$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -2.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		$I_O = -3.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.8	-	3.70	-	V

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
V <sub>OL</sub>	LOW-level output voltage	Q; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
		I <sub>O</sub> = 50 µA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 µA; V <sub>CC</sub> = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 µA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		I <sub>O</sub> = 8.0 mA; V <sub>CC</sub> = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
		X2; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
		I <sub>O</sub> = 50 µA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 µA; V <sub>CC</sub> = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 50 µA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 2.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
I <sub>O</sub> = 3.0 mA; V <sub>CC</sub> = 4.5 V	-	-	0.36	-	0.44	-	0.55	V		
I <sub>I</sub>	input leakage current	X1; V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	µA
I <sub>CC</sub>	supply current	V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 5.5 V	-	-	1.0	-	10	-	40	µA
C <sub>I</sub>	input capacitance	X1	-	3	8	-	8	-	8	pF

## 11 Dynamic characteristics

**Table 7. Dynamic characteristics**

GND = 0 V; t<sub>r</sub> = t<sub>f</sub> = ≤ 3.0 ns. For test circuit see [Figure 7](#). For waveforms see [Figure 5](#) and [Figure 6](#).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
t <sub>pd</sub>	propagation delay	X1 to X2 <sup>[1]</sup>								
		V <sub>CC</sub> = 3.0 V to 3.6 V <sup>[2]</sup>								
		C <sub>L</sub> = 15 pF	-	3	7	1	11	1	13	ns
		C <sub>L</sub> = 50 pF	-	7	13	1	16	1	18	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V <sup>[3]</sup>								
		C <sub>L</sub> = 15 pF	-	2	5	1	7	1	9	ns
		C <sub>L</sub> = 50 pF	-	6	10	1	11	1	12	ns
		X1 to Q <sup>[1]</sup>								
		V <sub>CC</sub> = 3.0 V to 3.6 V <sup>[2]</sup>								
		C <sub>L</sub> = 15 pF	-	33	55	1	67	1	78	ns
		C <sub>L</sub> = 50 pF	-	35	60	1	71	1	82	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V <sup>[3]</sup>								
		C <sub>L</sub> = 15 pF	-	23	36	1	44	1	52	ns
		C <sub>L</sub> = 50 pF	-	25	40	1	51	1	58	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
t <sub>W</sub>	pulse width	X1 HIGH or LOW								
		V <sub>CC</sub> = 3.0 V to 3.6 V	4	-	-	5	-	7	-	ns
		V <sub>CC</sub> = 4.5 V to 5.5 V	3	-	-	4	-	5	-	ns
f <sub>max</sub>	maximum frequency	X1								
		V <sub>CC</sub> = 3.3 V	125	-	-	100	-	70	-	MHz
		V <sub>CC</sub> = 5 V	165	-	-	125	-	100	-	MHz
C <sub>PD</sub>	power dissipation capacitance	C <sub>L</sub> = 50 pF; f <sub>i</sub> = 1 MHz; V <sub>I</sub> = GND to V <sub>CC</sub> [4]								
		V <sub>CC</sub> = 3.3 V	-	4	-	-	-	-	-	pF
		V <sub>CC</sub> = 5 V	-	5	-	-	-	-	-	pF

[1] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

[2] Typical values are measured at V<sub>CC</sub> = 3.3 V.

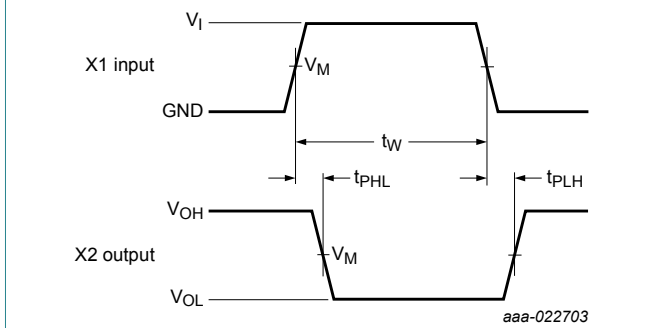
[3] Typical values are measured at V<sub>CC</sub> = 5.0 V.

[4] C<sub>PD</sub> is used to determine the dynamic power dissipation P<sub>D</sub> (μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i + C_L \times V_{CC}^2 \times f_i / 16384$  where:

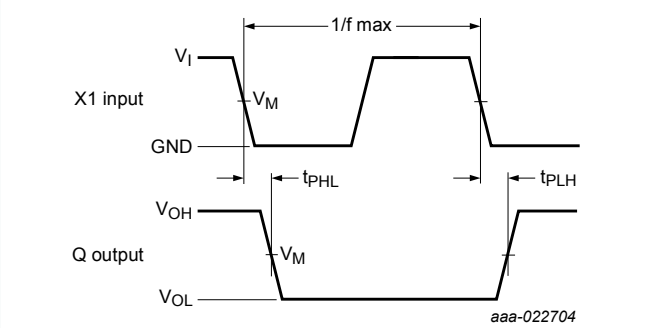
f<sub>i</sub> = input frequency in MHz; C<sub>L</sub> = output load capacitance in pF; V<sub>CC</sub> = supply voltage in Volt.

11.1 Waveforms and test circuit



Measurement points are given in [Table 8](#).  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Figure 5. Input X1 to output X2 propagation delay times**

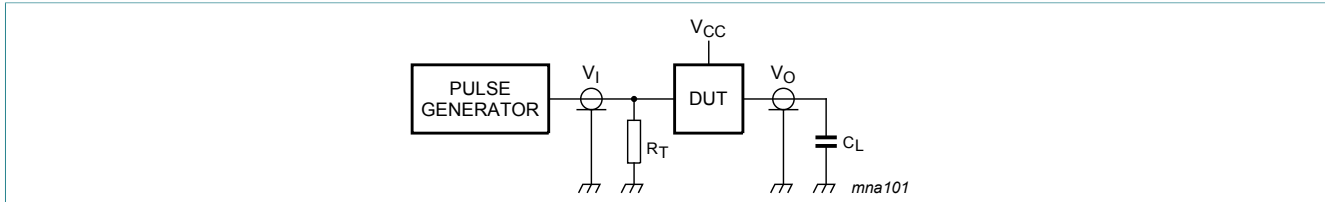


Measurement points are given in [Table 8](#).  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Figure 6. Input X1 to output Q propagation delay times**

**Table 8. Measurement points**

Inputs		Output
$V_I$	$V_M$	$V_M$
GND to $V_{CC}$	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$



Test data is given in [Table 7](#). Definitions for test circuit:  
 $C_L$  = Load capacitance including jig and probe capacitance.  
 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

**Figure 7. Test circuit for measuring switching times**

## 12 Crystal oscillator

### 12.1 Typical crystal oscillator circuit

A typical crystal oscillator schematic is shown in [Figure 8](#). R1 is the power limiting resistor, its value depends on the frequency and required stability against changes in  $V_{CC}$  or average  $I_{CC}$ . For starting and maintaining oscillation a minimum transconductance is necessary, so R1 should not be too large. A practical value for R1 is 2.2 k $\Omega$ .

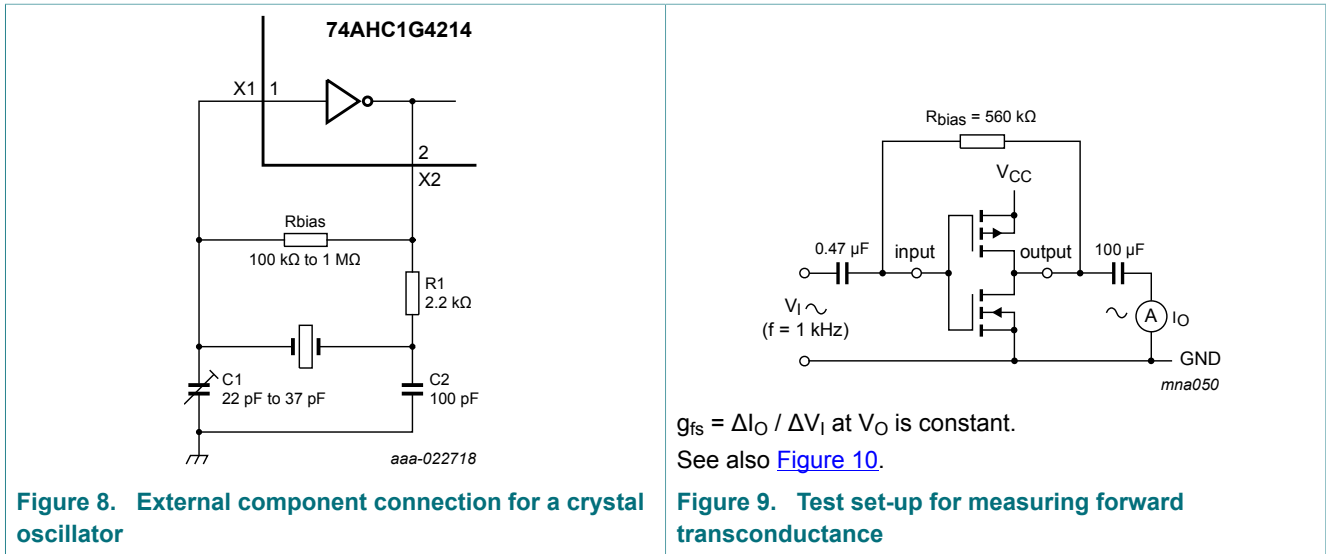


Figure 8. External component connection for a crystal oscillator

Figure 9. Test set-up for measuring forward transconductance

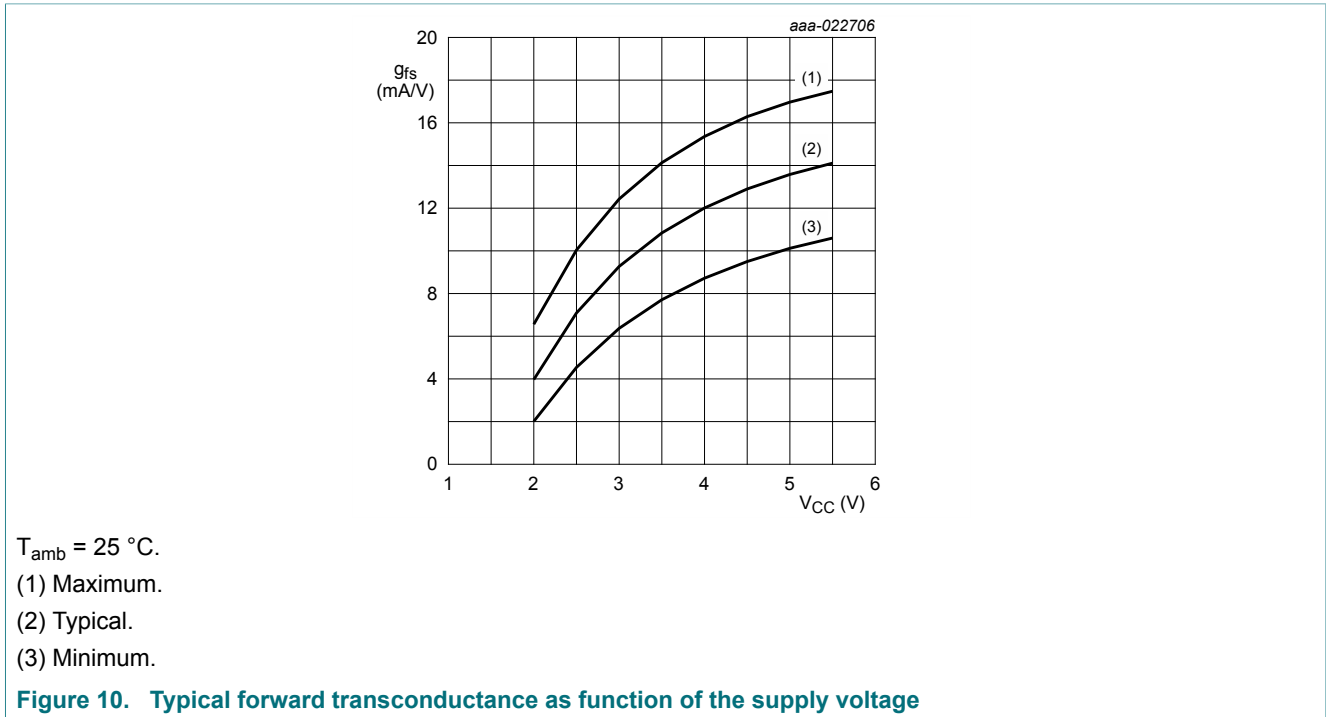


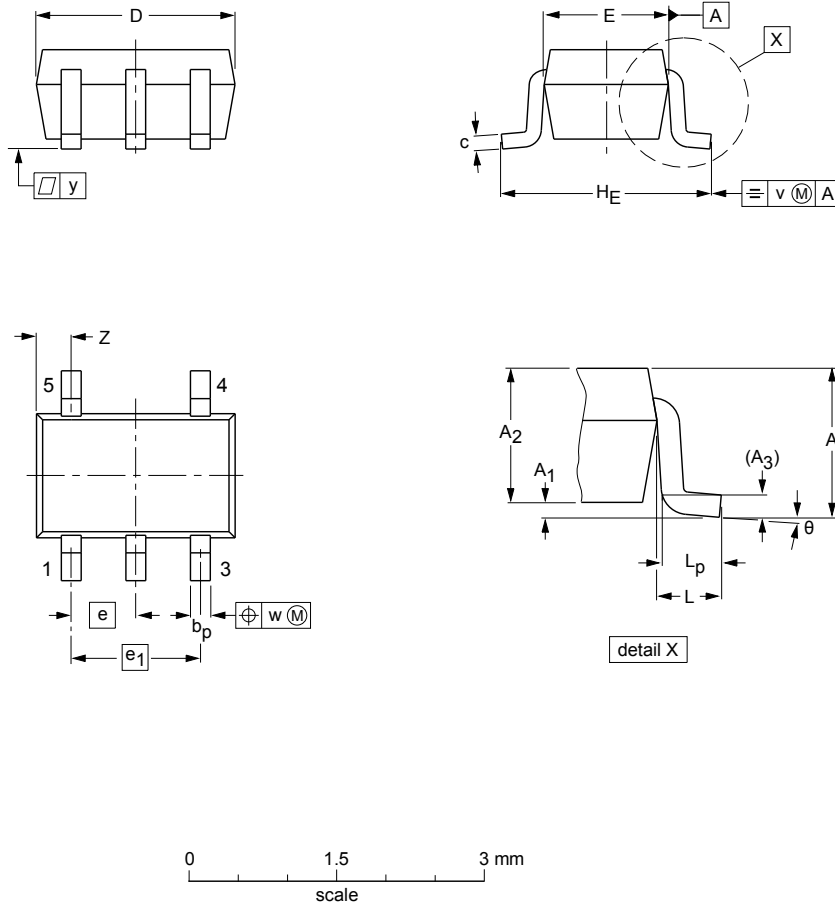
Figure 10. Typical forward transconductance as function of the supply voltage



13 Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	H <sub>E</sub>	L	L <sub>p</sub>	v	w	y	Z <sup>(1)</sup>	θ
mm	1.1	0.1 0	1.0 0.8	0.15	0.30 0.15	0.25 0.08	2.25 1.85	1.35 1.15	0.65	1.3	2.25 2.0	0.425	0.46 0.21	0.3	0.1	0.1	0.60 0.15	7° 0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
SOT353-1		MO-203	SC-88A		00-09-01 03-02-19

Figure 11. Package outline SOT353-1 (TSSOP5)

## 14 Abbreviations

Table 9. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

## 15 Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AHC1G4214 v.3	20180426	Product data sheet	-	74AHC1G4214 v.2
Modifications:	<ul style="list-style-type: none"> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>			
74AHC1G4214 v.2	20161026	Product data sheet	-	74AHC1G4214 v.1
Modifications:	<ul style="list-style-type: none"> <li>Type number 74AHC1G4214GM removed.</li> </ul>			
74AHC1G4214 v.1	20160415	Product data sheet	-	-

## 16 Legal information

### 16.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

### 16.2 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

**Short data sheet** — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 16.3 Disclaimers

**Limited warranty and liability** — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia. In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory. Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of Nexperia.

**Right to make changes** — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical

systems or equipment, nor in applications where failure or malfunction of an Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification. Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products. Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

**Limiting values** — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

**Terms and conditions of commercial sale** — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nexperia.com/profile/terms>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Non-automotive qualified products** — Unless this data sheet expressly states that this specific Nexperia product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Nexperia accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications. In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Nexperia's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond Nexperia's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Nexperia for any liability, damages or failed product claims resulting from customer

design and use of the product for automotive applications beyond Nexperia's standard warranty and Nexperia's product specifications.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

## 16.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.